1B Paper 8 - Section H. - Civil + Structural. Eng.

Q. 1 Solution

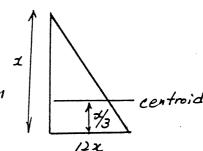
(a) Since the slab's own weight in ignored, the loading on the underside of the slab should be full hydrostatic pressure with no soil pressure : $\omega = 40 \text{ KN/m}^2$

[2]

(b) In the side walls

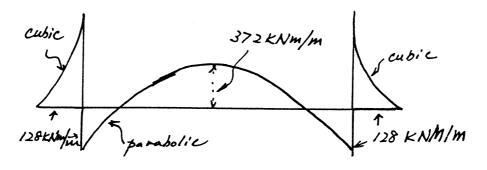
$$Moment = \frac{12x \cdot x}{2} \cdot \frac{x}{3} = 2x^3$$

when $\chi = 4$. Moment = 2.43 = 128 KNm/m



In the slab, free bending moment

=
$$\frac{\omega L^2}{8} = \frac{40 \times 10^2}{8} = 500 \text{ kNm/m}$$
 at the centre.



Bending moment diagram

[6]

(C) Maximum moment to be resisted = 372 KNM/M

b=1000 mm fcu = 40 N/mm2

(d) . At the centre of the slab

If the slab is minimum thickness, then neutral axis will be at d/2: n: 1/2

from Data book, 32 mm bar is 804 mm

Could use 32 mm bar at 160 mm centre-to-centre spacing 10.

· At the corners, moment applied is less than the maximum the section can accompodate : neutral axis will be at < d/2 and need to iterate to find the neutral axis.

Guess that the neutral axis is at \(\frac{128}{272}\cdot 0.5d = 0.17d\) Estudents do not need to start with this value, any reasonable Starting point will do.]

$$128 \cdot 10^6 = 0.87 \cdot 460 \cdot As \cdot 250 \left(1 - \frac{0.17}{2}\right)$$
 (data book)
 $\Rightarrow As = 1398 \text{ mm}^2/\text{m}$

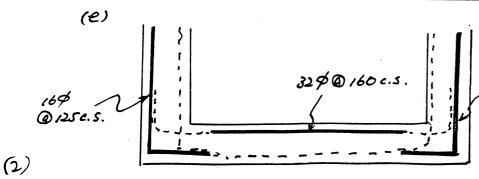
Find new position of the neutral axis.

New value of As = 1375 mm2/m

from Data book. 16 mm bar is 20/mm2

16 mm bar at 146 mm centre- to centre spacing

weeded. could use 16mm bar at 125 C.S.

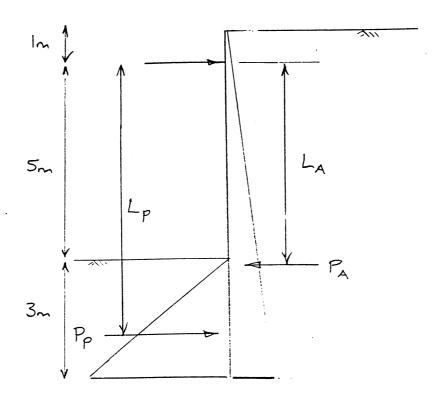


Secondary steel shown dushed.

[6]

[2]

Question \$ 2. Solution



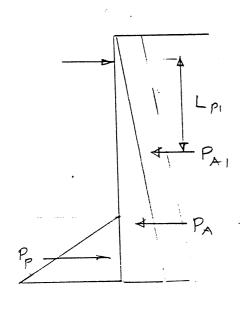
$$\phi' = 35^{\circ}$$
 $K_{\alpha} = \frac{1 - \sin \phi'}{1 + \sin \phi'} = 0.27$
 $K_{p} = 1/K_{\alpha} = 3.68$

Factor of safety against no totomal failure F = Pp. Lp
Pa. La

$$P_A = \frac{1}{2} \times 0.27 \times 17 \times 9^2 = 186 \text{ kN/m}$$
 $L_A = 5m$
 $P_P = \frac{1}{2} \times 3.68 \times 17 \times 3^2 = 281 \text{ kN/m}$
 $L_P = 7m$

$$F = \frac{281 \times 7}{186 \times 5} = \frac{2.1}{8}$$

(i) Effect of 2m surcharge



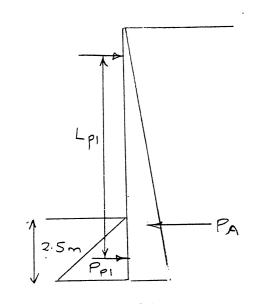
Pa, Pp, La, Lp as before but additional force PAI and lever arm Lp1

PAI = 0.27 x 17 x 2 x 9 = 82.6 kN/m "L'AI = 3.5m

$$F = \frac{281 \sqrt{7}}{(186 \times 5) + (82.6 \times 3.5)} = \frac{1967}{930 + 289}$$

$$= 1.61$$
(4)

(ii) Effect of 0.5m overdig



PA, LA as before

Pp1 = 1 × 3.68 × 17 × 2.52 = 195 kN/m $LP1 = (2 \times 2.5) + 5.5 = 7.17m$

$$F = \frac{195 \times 7.17}{186 \times 5} = \frac{1.50}{4}$$



Pp, Lp as for lit case PAZ = \frac{1}{2} \times 0.27 \times (20-10) \times 92 = 109 km/m $P_{W} = \frac{1}{2} \times 10 \times 9^{2} = 405 \text{ kN/m}$ LA = 5m (as Lefore)

$$F = \frac{281 \times 7}{(109 + 405)5} = \frac{0.76}{4}$$

Question 3 Solution

Stability

The choice of tunnel excavation method must be such that the tunnel heading will remain stable during construction. Key factors affecting stability are:

- Ground conditions permeable or impermeable (ie sands, gravels or clays)
- Groundwater conditions is tunnel above or below water table?
- Depth of tunnel this affects stability ratio in clays (ratio of total vertical stress at tunnel axis level to undrained shear strength of clay)

If tunnel is to be in impermeable ground, i.e. clays, and if the clay has sufficient undrained shear strength (stability ratio less than about 5), tunnel can be constructed in open face mode – i.e. no face support would be needed.

If the tunnel is to be in permeable ground, i.e. sands, gravels, or in soft clay where the stability ratio would be too high without face support (greater than about 5), then the tunnel must be constructed in <u>closed face</u> mode. This means a slurry or earth pressure balance machine.

An alternative to a closed face machine would be to use ground treatment to deal with the problem of water, either by grouting (if feasible) or by ground water lowering.

[4]

Ground movements

Ground movements are inevitably caused by tunnelling in soft ground. Beneath cities this potentially could be a problem if there are buildings, structures or services (including existing tunnels) which may be damaged by movements.

Particularly vulnerable are old masonry buildings on shallow foundations. These are more prone to damage to differential settlement in the hogging mode. The key factor leading to damage is the magnitude of tensile strain induced in the building. The stiffness of the building is often significant in reducing differential settlement; overall tilt of a building is not generally damaging. Old services such as cast-iron water or gas mains are also vulnerable to differential settlement.

Tunnel lining

Tunnel linings can be precast segmental concrete (bolted or unbolted), segmental cast iron or sprayed concrete followed by cast in-situ concrete. In high speed construction, such as in running tunnels for a metro, segmental linings are usually selected. If the ground is low permeability stiff clay (eg London Clay) unbolted expanded linings are used. In other ground conditions the segments are always bolted. Sprayed concrete is generally only used for larger size tunnels (eg for station tunnels). [2]

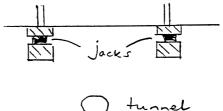


Possible protective measures

- 1. Tie rods can be used to strengthen weak masonry buildings.
- 2. Where the ground conditions allow, chemical grouting of sands or gravels beneath buildings on shallow foundations results in the building effectively being founded on a stiff raft. It is therefore able to withstand differential settlement of the ground by responding in a much more rigid mode.

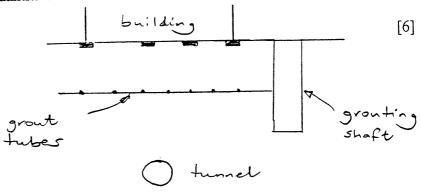


3. Positive jacking can be used. This involves cutting of a foundation, inserting hydraulic jacks and then jacking in response to measurements of movements so that the building is maintained at the same level.



4. Compensation grouting comprises the injection of grout (usually cementitious) into the ground between the tunnel and the building to be protected in such a way that the volume of grout injected compensates for the volume of ground "lost" into the tunnel. Grout tubes must be installed before tunnelling commences.

Instrumentation must be installed on the building and in the ground to monitor carefully the movements, so that grouting can be undertaken at the right time and in the right quantities.



Instrumentation

Typical instrumentation:

<u>Settlement</u> monitoring stations, on the <u>ground surface</u>, and on <u>buildings</u> to allow precise levelling. Stations on ground surface to be along centre line of tunnel and also, at intervals, to be along transverse sections.

In special circumstances, for example where buildings are especially sensitive and/or compensation grouting is being used as a protective measure, they might also have <u>electrolevels</u> installed on them, so that differential settlements are monitored automatically.

Also in special cases, instruments to measure <u>horizontal strain</u> induced in buildings can be useful.

<u>Subsurface</u> instrumentation in the ground: <u>vertical</u> movements by rod extensometers or magnetic rings or by horizontal (or near horizontal) boreholes with electrolevels; <u>horizontal</u> movements by vertical inclinometers installed in boreholes.

In soft clays, piezometers to measure pore pressure changes.

In closed face tunnelling machines, pressure gauges to monitor pressure of slurry in the case of slurry machines or of spoil in the case of EPB machines.

[5]



IB Paper 8 - Seetin B Mechanial Engineering

A = spanning pipe - most displacement - least stiffen

B = exposed pipe

C = buried pipe - least displacement - most offliers

Type of extation in likely to be a shaker, finite displacement at low frequency, displacement reduces to zero at high frequency. (Shaker force to drive many is independent of frequency).

(b) lesponse is date-book care (a).

From data-book peak occurs at w/w = 11-22

 $\frac{\times_{\text{max}}}{\text{V-Y}} = \frac{1}{2c\sqrt{1-c^2}}$

at lower frequencies $\frac{X}{KY} \rightarrow 1$

hence $\frac{x_{\text{max}}}{x_{\text{o}}} = \frac{1}{2c\sqrt{1-c^2}} = 1.75$ (from plot)

this leads to a quarkic in c (quadratic in c²) and values for cof ± 0.954 and ± 0.3.

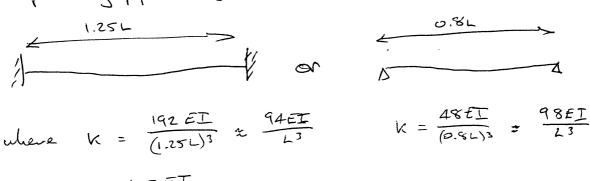
The only sensible answer is c=0.3.

From the plot (with care of log scale) peak is at 4.5 Hz

Hence wn = Ji-2ct

... for 2 5 Hz

4(c) Spanning pipe may be modelled as:

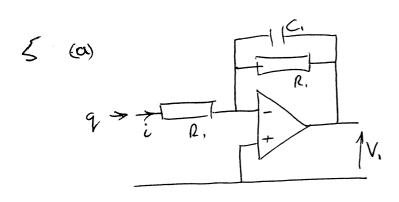


1. h & 100 EI

assuring equivalent mass = 1/2 span wars at centre span:

(d) Heasuring the displacement x. frequency response require a lot of olde and milliple extation frequencies. A shaken could be down by a sweeping frequency and the vessitant displacement measured. However, transients will effect the result.

Better to measure at one frequency (a two) to discriminate types of brial.

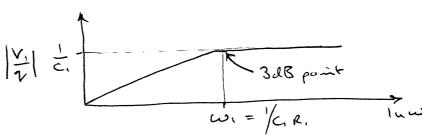


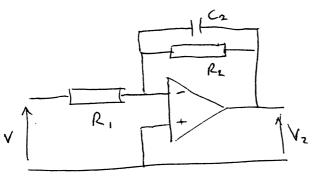
$$\dot{c} = \frac{dq}{dt}$$

at -ve terminal:

$$\frac{V_{i}}{q} = \frac{\int \omega R_{i}}{1 + \int \omega C_{i} R_{i}}$$

high-pass fille



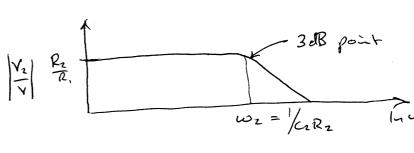


at -ve terminal:

$$\frac{V_1}{R_1} + \frac{V_2}{R_2} + V_2 \int_{\infty} C_2 = 0$$

$$\frac{V_2}{V} = \frac{R_2/R_1}{1 + j\omega C_2 R_2}$$

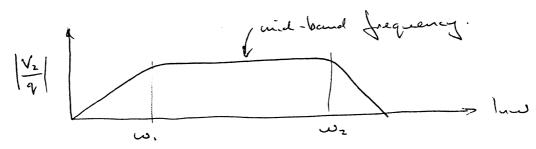
las-pass lite



5 (b) The two circuits may be combined serially with Vi connected to V.

The resultant gain is given by: $\frac{V_2}{q} = \frac{j \omega R_1}{1 + j \omega C_1 R_2} \frac{R_2/R_1}{1 + j \omega C_2 R_2}$

For a band-pass filter we > w., hence /cre. > /c.R.



In addition for practical circuits chose all resistences to be less than 100MD. (less than opening input impedance).

(c) For a mid-band frequency, wo, of 15 Hz:

 $\frac{\omega_0}{\omega_1} = \frac{\omega_1}{\omega_0}$

 $\omega_1 \omega_2 = \omega_0^2$

/c,e, · /c,e, = w?

now $R_z = 10 R$, and $C_z = 10^3 C$, hence on substitution and rearrangement: $\frac{1}{C_1 R_2} = \frac{100}{100} = 9.4$

5 '(c) If the gain is also fixed at wid-band:

Mid-bound gain 2 C. R. where Rz=10R.

 $\frac{1}{c_1}$. 10 = 100 x 10⁻⁶ and $c_1 = 0.1$ p. F

Then R. = 1.1 Mr

R2 = 10.1 M2

 $C_{1} = 0.1 \mu F$ $C_{2} = 0.1 \mu F$

(d) Sampling frequency = 2 x maximum frequency of interest.

Set maximum frequency at higher 3dB point to enoure mid-band is included.

:. Sampling frequency = 2 × 150 = 300 Hz

(e) Dynamic vange of 60 dB in the voltage signal represents a 1000 to 1 vange.

To capture this variety in digital form 10 bils are required since 2° = 1024

Hence, 4 signals at 300 Hz of 10 bits for 20 hours

= 4 x 300 × 10 x 20 x 60 x 60

= 864 Mbils

= 108 Mbzter.

6 (a) Spérification should include reference to force requirement, site, frequency range, stroke. Estamater for value are required also.

holde referre to geographical market, mantenance, control requirements etc.

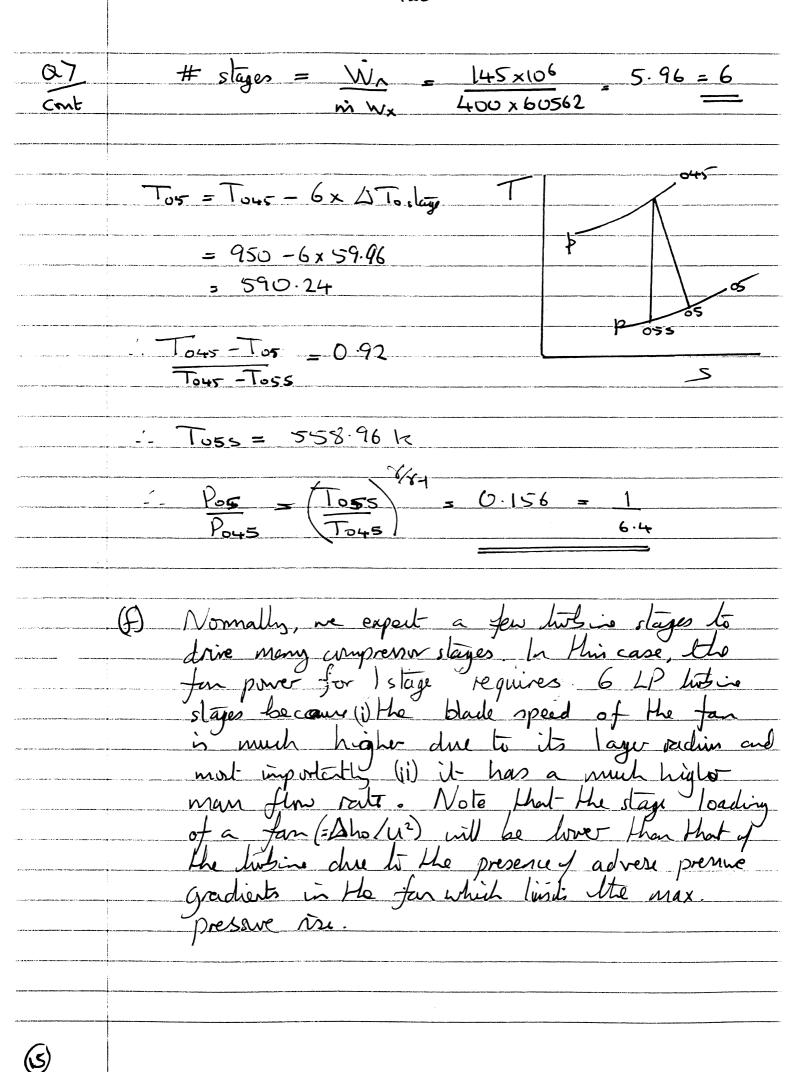
Identify demands and wisher in the specification.

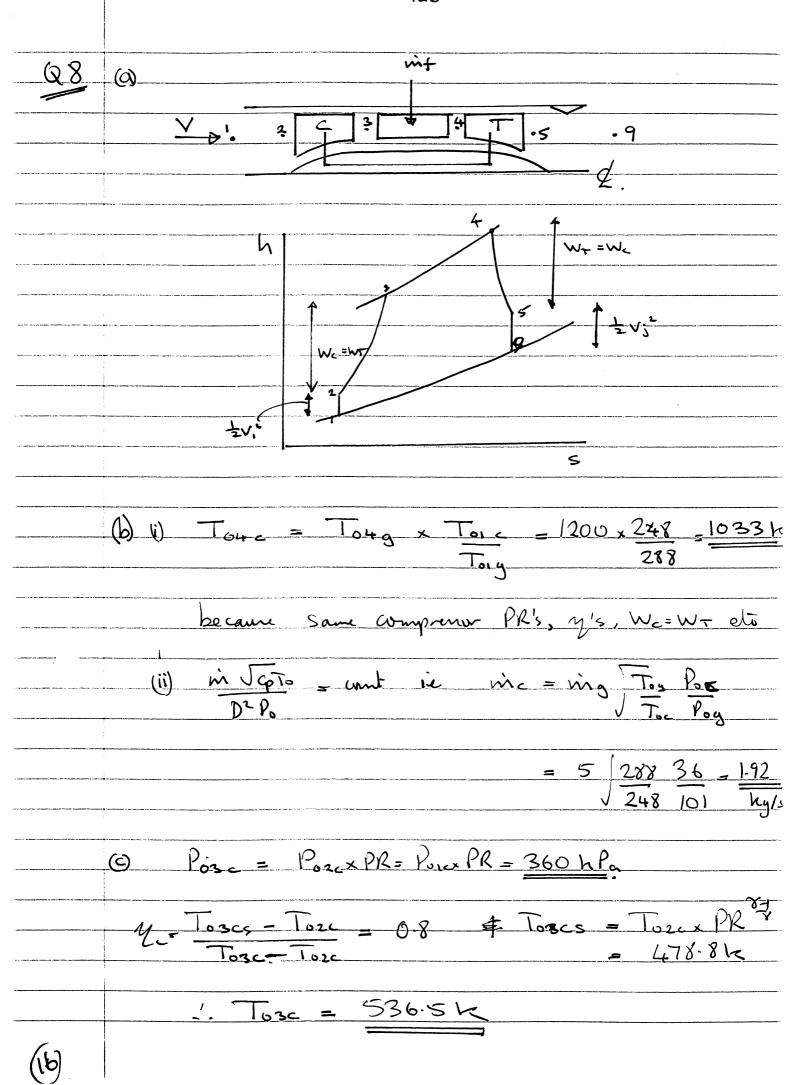
- (b) Highert risk? increasing Jones land? product support?
- (c) Follow stages of BS 7000 motivation (need - planning, feasibility Cueulian - deig development, production.
- (d) FREA look at efect of individual comprent failure and both for reason of failure to iteatify actions to reduce chancer of failure.

Apply to shake at conceptual deig slage when the system artifecture in known. Continue to apply thoughout the subsequent development.

	SECTIONS DERUTHURMA ENVINORENCE.
0.7	(a) In the stator, the stagnature P&T are enertially ansland, the velocity increases and co the pressure falls. In the volue, if the vadin is ansland, the relative stagnature P&T are essentially unsland, the relative velocity increases and to the pressure falls.
	(b) Statur Eich / Kotur Inlut Rotur Exit / Statist hel
	de d
	(c) $x_1 = 60.3^{\circ}$ $x_2^{RR} = 36.3^{\circ}$ $y_2 = 156 \text{ m/s}$ $y_3 = 155.21 \text{ m/s}$
	$(d) W_{x} = U(V_{\Theta2} - V_{\Theta3}) Y = 156 mls$
	Voz = Vxta dz ; Kz = 60.3. Voz = Vx (Z dz ; Kz = -36.8. (Noti-re)
	1. Wx = 60562 W/lys-7 DT. = Wx = 59.96 N
	© Tous = 950 kg s ⁻¹ $\dot{W}_{x} = 145 \text{ MW}$

W





M = 0.85 = Touc - Tosc LT Touc - Toscs Q8 (d) ant To4 =1033.3 k Cp = 1010 WT = WC > Tos = To4 - [To3-To2] <u>= (033.3- [536.5-248]</u> -. Toss = 693-8 Pos = Pou (Toss) = 89.32 hPa (e) bentopic: Ty (pg) 8-1/4 (89.32) 13.5 0.6744 :. Tq = 502.23 k SFEE: GTg + = Vg2 = Cp Tos M = Vg = 699 1.56 >1 :- choke

\[
\text{VRT}_1 = \frac{699}{\text{V1.4x 287x 502}}
\] $X_g = m V_q = 1.92 \times 699 = 1.34 hN$ (f) V, = 1/2cp(Toi-Ti) = 252.2 M/s -'. Xn = in (Vg-V,) = 0.86 hn

(3)

Q9	(9) $\frac{y}{L^p} = \frac{\text{Power to aircroft}}{\text{Power to Jet .}}$
	$= \frac{V\left(\dot{m}_{\alpha} + \dot{m}_{f}\right)V_{j} - \dot{m}_{\alpha}V}{\frac{1}{2}\left((\dot{m}_{\alpha} + \dot{m}_{f})V_{j}^{2} - \dot{m}_{\alpha}V^{2}\right)}$
	$\frac{\text{Neglecting inf}}{\frac{1}{2}(V;^2-V^2)} = \frac{2V}{\frac{1}{2}(V;^2-V^2)} = \frac{2V}{V+V;}$
	High y implies that " it is better to accelerate a large man of air a little rather bhot vie resu". Hence the me of the bypan ergine.
	b) The two nunt-important-reasons are the types and the length of the running. A high speed is needed became of the limits on Cr.
	$\frac{Q}{2} = \frac{MQ}{2 \times 1.225 \times 90^2 \times 766} = \frac{[.60]}{2 \times 1.225 \times 90^2 \times 766}$
	(d)
	(e) Pa = 29 kPa } : Pa = b = 0.445 kg/m > AL Ta = 227k } RT
	From vector diagram, — 0 W I mg
	$L = W \omega \theta$ $X_n - D = W \omega \theta$

Gy L 20 = D = L = Wwo of 20

in Xn = Wsi of + Wwo of yward 20

To find 8:
$$M = 0.85$$
 .. $V = 0.85$ J KRT = 0.95 J + 4.217 × 227 = 2.56.7

$$0 = 12^{-1} \left(\frac{V_{N}}{V_{H}}\right) = 12^{-1} \left(\frac{1.5}{1.5}\right) = 0.9348^{-1}$$

$$\therefore X_{n} = 620 \times 10^{2} \times 9.81 \text{ fin } 0.9348 \times 10.03348}$$

$$= 239.644 \text{ fin}$$

$$\therefore X_{n} / Ergin = 84.9 | \text{fin}$$

$$X_{n} / Ergin = 84.9 | \text{fin}$$

$$34.911 = X_{n} = \text{in} (V_{j} - V_{j}) = 510 (V_{j} - 256.7)$$

$$\Rightarrow V_{j} = 423.2 \text{ m/s}$$

$$y_{p} = \frac{2 \times 256.7}{423.24256.7} = 0.755$$

1B. Paper 8 - Section D - Electrical Engineers

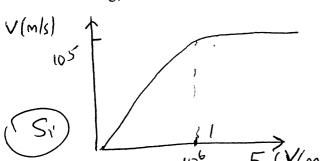


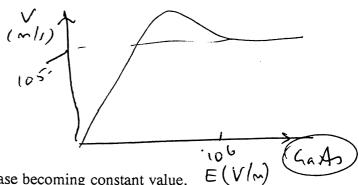
FCC has 4 sites per cell.

Electron concentration = $4/(3.61 \cdot 10^{-10})^3 = 8.5 \cdot 10^{28} \text{ m}^{-3}$.

$$\sigma=$$
Ne μ , so e $\mu=6.10^{7}/8.5.10^{28}=7.06.10^{-22}$ [$\mu=0.0044$ m²/V.s] $\sigma=7.06.10^{-22}.10^{21}=$ **0.7 ohm⁻¹ m⁻¹.**

Scattering limited velocity is when the maximum electron velocity is limited by phonon scattering, in which an electron loses all its KE in each collision with a phonon.





Show diagram of v vs. E, with linear increase becoming constant value.

Thus, $U_{ph} = 0.5 \text{mv}^2 = 0.5 \cdot 9.1 \cdot 10^{-31} \cdot (5 \cdot 10^4)^2 = 1.14 \cdot 10^{-21} \text{ J} = 0.0071 \text{ eV}.$

Critical field $E_S = v_S/\mu = 5.10^4/0.0044 = 1.14.10^7 \text{ V/m}.$

 $L = V/E_S = 2/1.14.10^7 = 1.76.10^{-7} \text{ m} = 0.176 \ \mu\text{m}.$

W/L not relevant.

 $\tau = L/v = 1.76.10^{-7} / 5.10^4 = 3.52.10^{-12} \text{ s.}$

 $\omega \tau = 1$, so $f_T = 1/2\pi\tau = 4.5$. 10^{10} Hz.



The gate drive must satisfy 2 conditions, $V_g < 2V$ and $E_{max} < E_{breakdown}$.

$$V_g = [eND^2]/[2\varepsilon]$$
 and

(1)

$$E_{\text{max}}^{B} = [eND]/\varepsilon,$$

(2)

where D is the layer thickness.

Breakdown is the more critical limit.

Dividing these equations gives

$$D = 2V_g/E_{max} = 2 \times 2/2.10^7 = 2.10^{-7} \text{ m}.$$

substitute for N into (2),

$$N = \varepsilon E/eD = 10^{-10} .2.10^7 / 1.6.10^{-19} 2.10^{-7} = 6.25.10^{22} m^{-3}. << N_{max}.$$

Use saturated electron velocity for fastest transit time transit time $\tau = L/v_S = 0.3 \cdot 10^{-6}/10^5 = 3 \cdot 10^{-12} = 3 \text{ ps.}$

Min field E needed for v_s is, $E = v_s/\mu = 10^5/0.01 = 10^7$ V/m. This is just less than breakdown field. This field gives the minimum source-drain voltage.

$$V_{ds} = E.L = 10^7.0.3.10^{-6} = 3V.$$

$$I_{\text{sat}} = \text{eNWDv}_{\text{S}} = 1.6.10^{-19} .6.25.10^{22} .10 \times 0.3.10^{-6} .2.10^{-7} .10^{5} = 6.10^{-4} \text{ A}$$

Q12.

Diff wear 0

Im Implantation ex

for smull fealures I.I test : of lawren anned lemp +: shorter out legth, it.

 $D \frac{\partial^2 C}{\partial x^2} = \frac{\partial C}{\partial L} \qquad (1)$

Show that $C = \frac{A}{JE} lxh \left[-\frac{Bx^2}{E} \right]$

in a solution

 $+ \frac{\partial c}{\partial k} = -\frac{1}{2} A t \frac{-3/2}{exp} \left(-6x^2 t^{-1}\right) + 8x^2 t^2 A t^2 exp[-6]$

 $\frac{\partial C}{\partial x} = -2AE^{-1/2}BxE^{-1}exp(-Bx^{2}E^{-1})$ = -2 ABE-3/2 De exp (-Bx2E-1)

 $\frac{\partial^2 C}{\partial x^2} = -2ABE^{-\frac{3}{2}} = +b - (Bx^2E^{-1}) + 2BxE^{-\frac{3}{2}} + 2BExE^{-\frac{3}{2}} = -Bx^2E^{-\frac{3}{2}}$

= -2ABt-3/2 + 4AB2t-8/2,2] exp[-6x2t-1]

5 ws. 3 + 3 mbo (1)

ic soln if D = 1/4B

$$D = D_0 = \sqrt{\frac{-E_A}{kT}}$$

$$\frac{D\left(T_{1}=1273\right)}{D\left(T_{2}=1173\right)}=\frac{4h\left(-\frac{E_{A}}{kT_{I}}\right)}{e_{xh}\left(-\frac{E_{A}}{kT_{L}}\right)}$$

 $K = 1.4 \times 10^{-23}$

$$\frac{D(1273)}{D(1173)} = e_{1} \left[\frac{1}{1.1 \times 1.6 \times 10^{-19}} \left[\frac{1}{1.4 \times 10^{23} \times 1273} \right] + \frac{1}{1.4 \times 10^{-13}} \right]$$

2.36

i.e deff. coeff at 900°C is 2.36 smalle that Ital at 1000's

In anome

23

1B Paper 8.

SEZTION E - INFORMATION ENGWEERING

Answer 13

- (a) Light enough to wear. Probably have a wireless network. Use little power so as to last a year or more without user recharging. Probably have some simple user I/O and simple automatic sensor and configuration systems. Look smart.
- (b) The Active Badge is a wearable computer used primarily for location purposes. It transmits an infra-red identification pulses every 15 seconds or so. The transmissions are diffuse and are picked up by receivers within a confined physical space. Infra-red radiation does not go through walls so the location of an Active Badge can be associated with a particular physical space. If attached to a thing an Active Badge provides a strong hint of where the thing is.
- (c) Deep sleep mode based on simple RC timeout.

 Sleep mode based on synchronised low-power accurate clocks.

 Don't have receiver on all the time, only switch it on just after a transmission. Use efficient scheme for transmissions (eg pulse position modulation).

 Design overall system so as to bias power use to the backbone.

 Use solar, piezo, mechanical, or some other continous recharger.

 Use low-power semiconduinctor process in implementation.

 Use fancy architectural approach in design (eg asynchronous).

Answer- 14

- (a) The operating system keeps process state in data structures called *process descriptors*. Each descriptor contains all the state information associated with a process, typically:
 - Process ID
 - Address space information
 - File descriptors (and other I/O handles)
 - Thread Information
 - Thread ID
 - State {blocked, running, runnable}
 - Program counter and register state
 - Stack information
 - Thread priority
 - Timeslice information

If the process is multi-threaded, then multiple thread descriptors are notionally attached to a process.

Process descriptors are stored in a process table. Multiple run queues are implemented by chaining together process threads for scheduling purposes.

(b) In accessing the file system, a system call, such as read or write, is used. A system call is a privileged instruction, executed in the context of the operating system. The filing system call manages the taking of data from memory/putting data into memory to/from disk, using the lower layers of I/O management and the relevant device driver. The system call will also mark the process as blocked, by executing a WAIT operation. The event to be waited for is the event that the disk operation has been completed. The thread will also be moved from its current queue to a blocked queue.

The WAIT operation affects the process descriptor by saving the current program counter, registers and stack, as well as marking the process state as blocked.

Other events that might cause the thread to block are other types of device access system calls or the thread running out of time in its timeslice.



- (c) Two stages are involved in the thread recommencing running:
- The thread must be unblocked and marked as runnable

This occurs if the device operation requested has completed. An interrupt signalling this is handled by the relevant interrupt service routine. The SIGNAL operation is then invoked for the event in question thus unblocking the blocked process.

This affects the process descriptor by changing the state from blocked to runnable.

• The thread must be scheduled to run

The thread is now added to a runnable process queue. When it is eventually scheduled, the PC, registers, stack, address space information etc. are set up in hardware to allow the thread to run.

This affects the process descriptor by changing the state from runnable to running.



Answer , /

(a) The IDL is processed by an *IDL interface compiler* to generate *stubs* and *skeletons*. Stubs and skeletons are used to *marshal* the data associated with an object operation invocation into a form that can be transmitted over a network.

The stubs forms part of a client-side proxy version of the PLS object. If an operation invocation occurs and the proxy detects, by looking at the PLS service's object reference, that the PLS service is on another machine, then it will use the stubs. The stubs communicate with the CORBA ORB (linked as a library or running as another local process). The stub calls operations to marshal the data into a transmittable form, and the ORB communicates with an ORB on the target machine (using IIOP - connecting to a internet address and port, extracted from the object reference) and transmits the relevant information (object reference, operation and marshalled parameters). An object adaptor is used to locate the relevant object within the service address space. For the PLS service this is easy, as there is just one.

The skeletons form part of the server-side PLS object implementation. They interact with the ORB to enable the receipt of the operation name and the unmarshalling of the operation parameters.

It is also possible to perform dynamic invocations, i.e. without compiling the IDL interface. In the context of this question, this information is not necessary. Full marks are obtainable without it. It is included for completeness.

To use dynamic invocation, IDL interfaces are stored in an *interface repository*. A dynamic invocation interface (equivalent of stub) accesses the interface representation from the repository, providing it with the information needed to transmit the operation invocation over the network. At the other end, a dynamic skeleton interface, also having accessed the interface repository, is able to decode the operation.

(b) To initially locate and bind to a distributed object like the PLS service, an *object reference* is required. This is an opaque encoding of an object's location: host, port (and thus process) and object within the process.

In order to obtain initially an object reference for the PLS service, a distributed client can contact a *naming service*. A naming service is a distributed object with a well-publicised object reference. The naming service stores mappings between object name and object reference. A request to the naming service includes the name of the object in question and returns the relevant object reference(s).



(c) To extend your architecture to deliver notification immediately it is detected that a pet has gone out requires a *callback* architecture.

A callback involves setting up an additional interface in the client process, something like the following:

```
interface PLSclient {
     void PetGoneOut(in string PetName)
}
```

This can then be called by the PLS service when a pet goes out, thus alerting the client.

The PLS service interface also has to be extended thus:

```
interface PLS {
    void InterestedClient(in PLSclient client);
    string PetLocation(in string PetName)
}
```

This extra operation allows clients that want to be informed to submit a reference to their callback interface. The PLS service stored such references and invoke the PetGoneOut operation on them as soon as it detects a pet has gone out.

